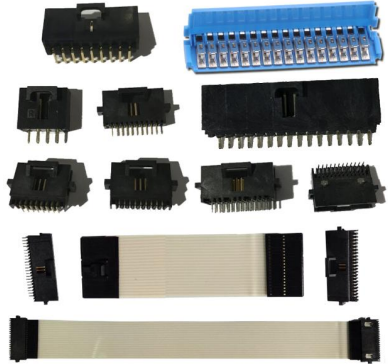
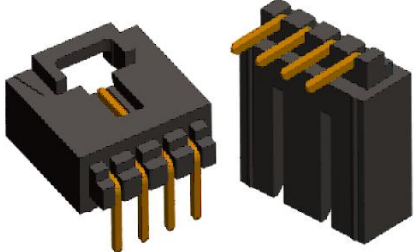
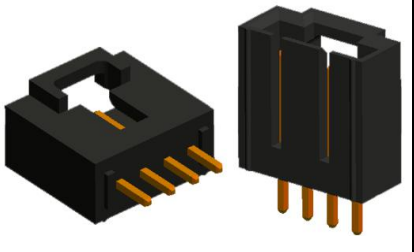
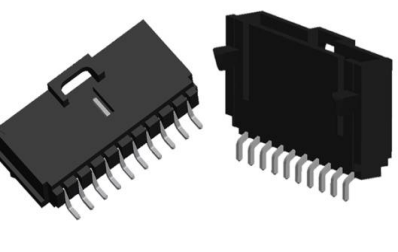
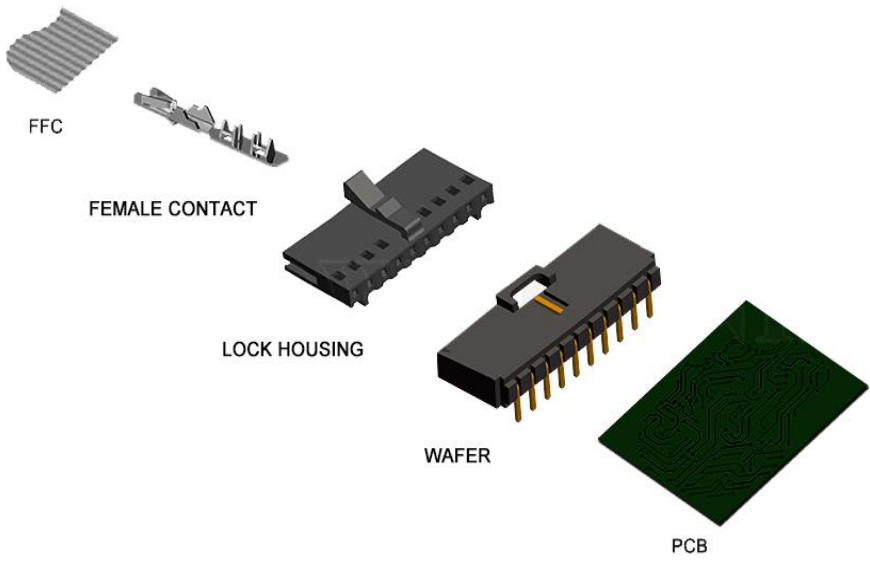
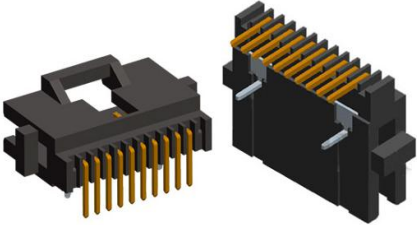
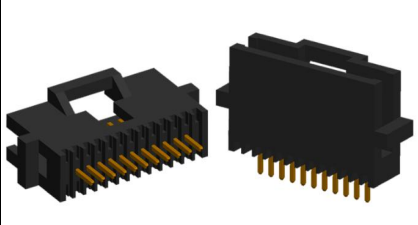
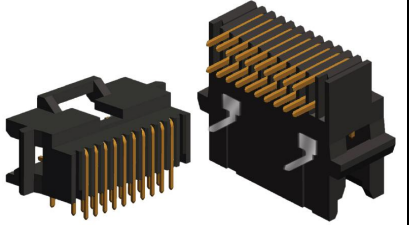
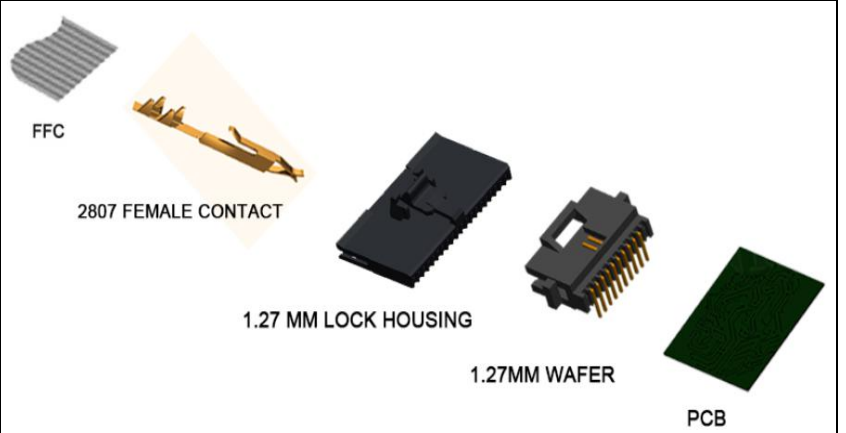
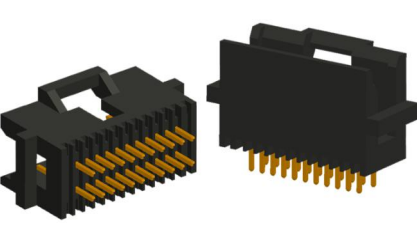
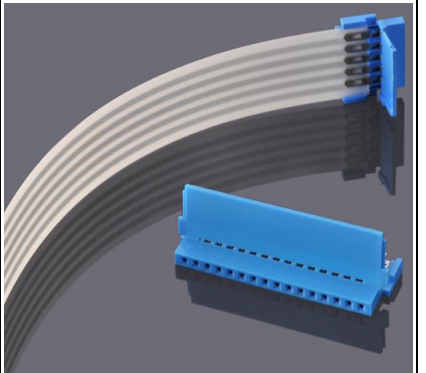


WAFER & CLINCHER

Specifications	Units	Image
Current rating	3A AC, DC	
Voltage rating	250V AC, DC	
Insulation resistance	1000 MΩ	
Contact resistance	20 mΩ	
Temperature range	-40°C ~ +105°C	
Wafer (Pitch 2.54mm)		
Part No: CL2545R-XXTNP	Part No: CL2545V-XXTNP	Part No: CL2545S-XXSNP
Material: BRASS/GOLD-FLASH & PBT+15%GF	Material: BRASS/GOLD-FLASH & PBT+15%GF	Material: BRASS/TIN-PLATED & LCP
PIN: 2~25	PIN: 2~25	PIN: 2~25
Packing: TUBE	Packing: TUBE	Packing: REEL
		
Application example using the 2.54mm Pitch Wafer		
		

Wafer (Pitch 1.27mm)		
Part No: CLSH1.27R-XXGNN	Part No: CLSH1.27V-XXGNN	Part No: CLSH1.27R-XXDGNN
Material: PHOSPHOR BRONZE GOLD OVER NICK/PA9T	Material: PHOSPHOR BRONZE GOLD OVER NICK/PA9T	Material: PHOSPHOR BRONZE GOLD OVER NICK/PA9T
PIN: 5/6/8/9/10/20/24/30	PIN: 5/6/8/9/10/20/24/30	PIN: 20/24
Packing: TUBE	Packing: TUBE	Packing: TUBE
		
Part No: CLSH1.27V-XXDGNN	Application example using the 1.27mm Pitch Wafer	
Material: PHOSPHOR BRONZE GOLD OVER NICK/PA9T	 FFC 2807 FEMALE CONTACT 1.27 MM LOCK HOUSING 1.27MM WAFER PCB	
PIN: 20/24		
Packing: TUBE		
		
2.54mm Pitch Clincher		Application example using the 2.54mm Pitch Clincher
Material: NYLON PA66	Material: NYLON PA66	
PIN: 2~30	PIN: 2~30	
PLATING: TIN	PLATING: GOLD	
